

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5535308

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RICHARD E. FACKENTHAL	08/15/2018
DANIELE VIMERCATI	08/14/2018
JAHANSHIR JAVANIFARD	08/15/2018
RECEIVING PARTY DATA	
Name:	MICRON TECHNOLOGY, INC
Street Address:	8000 SOUTH FEDERAL WAY
City:	BOISE
State/Country:	IDAHO
Postal Code:	83716-9632
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16104711
CORRESPONDENCE DATA	
Fax Number:	(303)473-2720
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	3034732700
Email:	mmmowry@hollandhart.com
Correspondent Name:	HOLLAND & HART LLP
Address Line 1:	P.O. BOX 11583
Address Line 4:	SALT LAKE CITY, UTAH 84147
ATTORNEY DOCKET NUMBER:	P269 (88231.0734)
NAME OF SUBMITTER:	MICHAEL L. DRAPKIN
SIGNATURE:	/Michael L. Drapkin/
DATE SIGNED:	05/22/2019
Total Attachments: 5	
source=P269 ASSIGN#page1.tif	
source=P269 ASSIGN#page2.tif	
source=P269 ASSIGN#page3.tif	
source=P269 ASSIGN#page4.tif	

ASSIGNMENT

WHEREAS, WE,

1. **Richard E. Fackenthal**, a citizen of the United States of America, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, U.S.A., and a resident of Carmichael, California,
2. **Daniele Vimercati**, a citizen of Italy, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, U.S.A., and a resident of El Dorado Hills, California,
3. **Jahanshir Javanifard**, a citizen of the United States of America, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, U.S.A., and a resident of Carmichael, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **ACCESS SCHEMES FOR SECTION-BASED DATA PROTECTION IN A MEMORY DEVICE** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **MICRON TECHNOLOGY, INC.** (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 8000 South Federal Way, Boise, Idaho 83716-9632, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under

International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

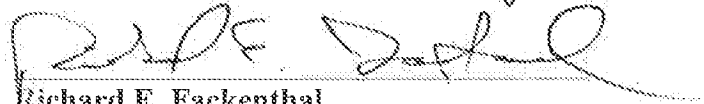
AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;


AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

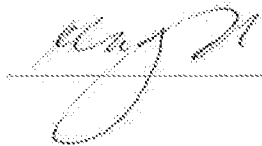
IN TESTIMONY WHEREOF, I have hereunto set my hand this 15 day of Aug., 2018


Richard E. Fackenthal

Witnessed By:

Signature: 

Printed Name: Xiawei Guo

Signature: 

Printed Name: Makoto Kitagawa

IN TESTIMONY WHEREOF, I have hereunto set my hand this 16th day of AUGUST, 2018.

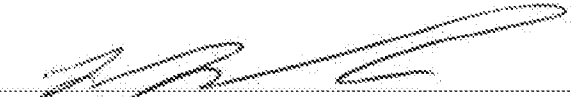
Daniele Vimercati
Daniele Vimercati

Witnessed By:

Signature: Xinwei Guo Printed Name: Xinwei Guo

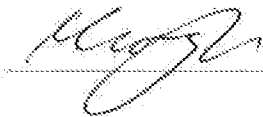
Signature: Richard Fackenthal Printed Name: Richard Fackenthal

IN TESTIMONY WHEREOF, I have hereunto set my hand this _____ day of _____, 20____.

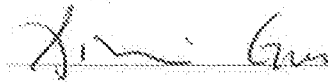


Jahanshir Javanifard

Witnessed By:

Signature: _____

Printed Name: Malcom Kiteyawa

Signature: _____

Printed Name: Xinwei Guo